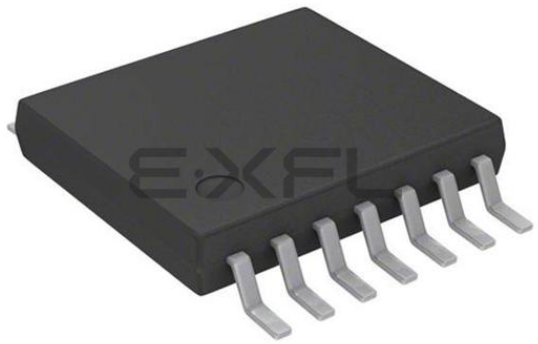

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	20MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	11
Program Memory Size	1.75KB (1K x 14)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	64 x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	14-TSSOP (0.173", 4.40mm Width)
Supplier Device Package	14-TSSOP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16f610-i-st

PIC16F610/16HV610 16-Pin Diagram (QFN)

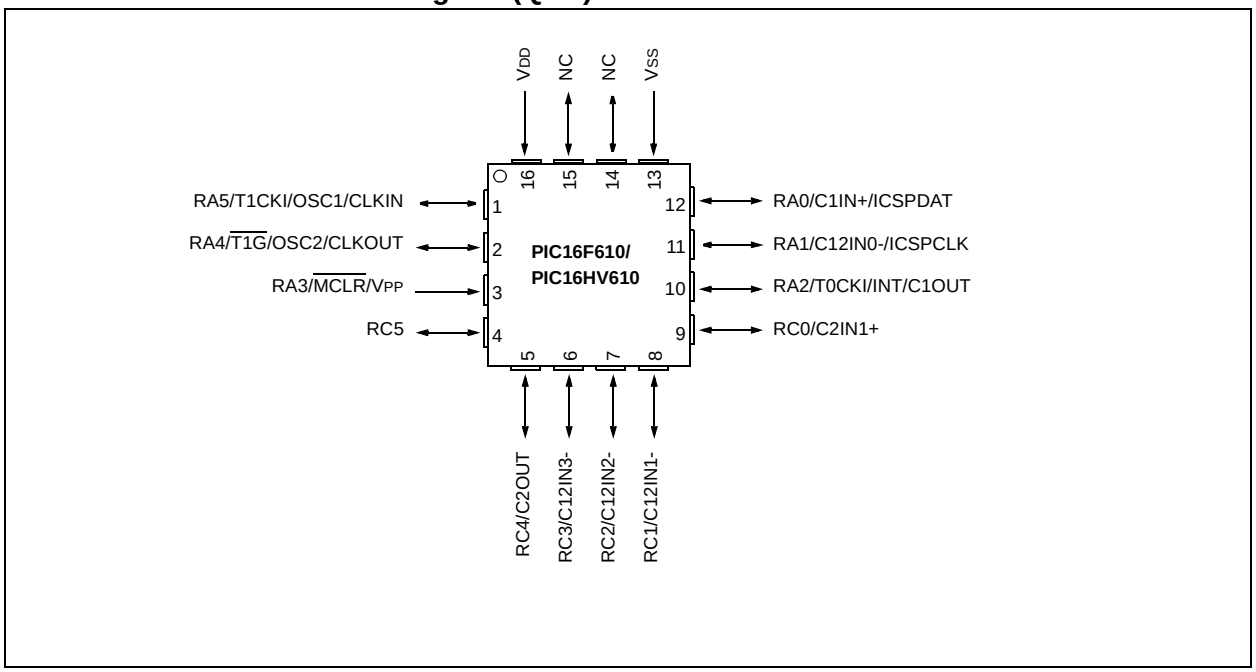


TABLE 3: PIC16F610/16HV610 16-PIN SUMMARY

I/O	Pin	Comparators	Timers	Interrupts	Pull-ups	Basic
RA0	12	C1IN+	—	IOC	Y	ICSPDAT
RA1	11	C12IN0-	—	IOC	Y	ICSPCLK
RA2	10	C1OUT	T0CKI	INT/IOC	Y	—
RA3(1)	3	—	—	IOC	Y(2)	MCLR/VPP
RA4	2	—	T1G	IOC	Y	OSC2/CLKOUT
RA5	1	—	T1CKI	IOC	Y	OSC1/CLKIN
RC0	9	C2IN+	—	—	—	—
RC1	8	C12IN1-	—	—	—	—
RC2	7	C12IN2-	—	—	—	—
RC3	6	C12IN3-	—	—	—	—
RC4	5	C2OUT	—	—	—	—
RC5	4	—	—	—	—	—
—	16	—	—	—	—	VDD
—	13	—	—	—	—	VSS

Note 1: Input only.

2: Only when pin is configured for external MCLR.

2.2.2.3 INTCON Register

The INTCON register is a readable and writable register, which contains the various enable and flag bits for TMR0 register overflow, PORTA change and external RA2/INT pin interrupts.

Note:	Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 2-3: INTCON: INTERRUPT CONTROL REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
GIE	PEIE	T0IE	INTE	RAIE	T0IF	INTF	RAIF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **GIE:** Global Interrupt Enable bit
1 = Enables all unmasked interrupts
0 = Disables all interrupts

bit 6 **PEIE:** Peripheral Interrupt Enable bit
1 = Enables all unmasked peripheral interrupts
0 = Disables all peripheral interrupts

bit 5 **T0IE:** Timer0 Overflow Interrupt Enable bit
1 = Enables the Timer0 interrupt
0 = Disables the Timer0 interrupt

bit 4 **INTE:** RA2/INT External Interrupt Enable bit
1 = Enables the RA2/INT external interrupt
0 = Disables the RA2/INT external interrupt

bit 3 **RAIE:** PORTA Change Interrupt Enable bit**(1)**
1 = Enables the PORTA change interrupt
0 = Disables the PORTA change interrupt

bit 2 **T0IF:** Timer0 Overflow Interrupt Flag bit**(2)**
1 = Timer0 register has overflowed (must be cleared in software)
0 = Timer0 register did not overflow

bit 1 **INTF:** RA2/INT External Interrupt Flag bit
1 = The RA2/INT external interrupt occurred (must be cleared in software)
0 = The RA2/INT external interrupt did not occur

bit 0 **RAIF:** PORTA Change Interrupt Flag bit
1 = When at least one of the PORTA <5:0> pins changed state (must be cleared in software)
0 = None of the PORTA <5:0> pins have changed state

Note 1: IOCA register must also be enabled.
2: T0IF bit is set when TMR0 rolls over. TMR0 is unchanged on Reset and should be initialized before clearing T0IF bit.

4.0 I/O PORTS

There are as many as eleven general purpose I/O pins and an input pin available. Depending on which peripherals are enabled, some or all of the pins may not be available as general purpose I/O. In general, when a peripheral is enabled, the associated pin may not be used as a general purpose I/O pin.

4.1 PORTA and the TRISA Registers

PORTA is a 6-bit wide, bidirectional port. The corresponding data direction register is TRISA (Register 4-2). Setting a TRISA bit (= 1) will make the corresponding PORTA pin an input (i.e., disable the output driver). Clearing a TRISA bit (= 0) will make the corresponding PORTA pin an output (i.e., enables output driver and puts the contents of the output latch on the selected pin). The exception is RA3, which is input only and its TRIS bit will always read as '1'. Example 4-1 shows how to initialize PORTA.

Reading the PORTA register (Register 4-1) reads the status of the pins, whereas writing to it will write to the PORT latch. All write operations are read-modify-write operations. Therefore, a write to a port implies that the port pins are read, this value is modified and then written to the PORT data latch. RA3 reads '0' when MCLRE = 1.

The TRISA register controls the direction of the PORTA pins, even when they are being used as analog inputs. The user must ensure the bits in the TRISA register are maintained set when using them as analog inputs. I/O pins configured as analog input always read '0'.

Note:	The ANSEL register must be initialized to configure an analog channel as a digital input. Pins configured as analog inputs will read '0' and cannot generate an interrupt.

EXAMPLE 4-1: INITIALIZING PORTA

```
BCF    STATUS,RP0      ;Bank 0
CLRF   PORTA           ;Init PORTA
BSF    STATUS,RP0      ;Bank 1
CLRF   ANSEL           ;digital I/O
MOVLW  0Ch             ;Set RA<3:2> as inputs
MOVWF  TRISA           ;and set RA<5:4,1:0>
                       ;as outputs
BCF    STATUS,RP0      ;Bank 0
```

REGISTER 4-1: PORTA: PORTA REGISTER

U-0	U-0	R/W-x	R/W-0	R-x	R/W-0	R/W-0	R/W-0
—	—	RA5	RA4	RA3	RA2	RA1	RA0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented**: Read as '0'

bit 5-0 **RA<5:0>**: PORTA I/O Pin bit
1 = PORTA pin is > V_{IH}
0 = PORTA pin is < V_{IL}

REGISTER 4-2: TRISA: PORTA TRI-STATE REGISTER

U-0	U-0	R/W-1	R/W-1	R-1	R/W-1	R/W-1	R/W-1
—	—	TRISA5	TRISA4	TRISA3	TRISA2	TRISA1	TRISA0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **Unimplemented**: Read as '0'

bit 5-0 **TRISA<5:0>:** PORTA Tri-State Control bit
1 = PORTA pin configured as an input (tri-stated)
0 = PORTA pin configured as an output

Note 1: TRISA<3> always reads '1'.
2: TRISA<5:4> always reads '1' in XT, HS and LP Oscillator modes.

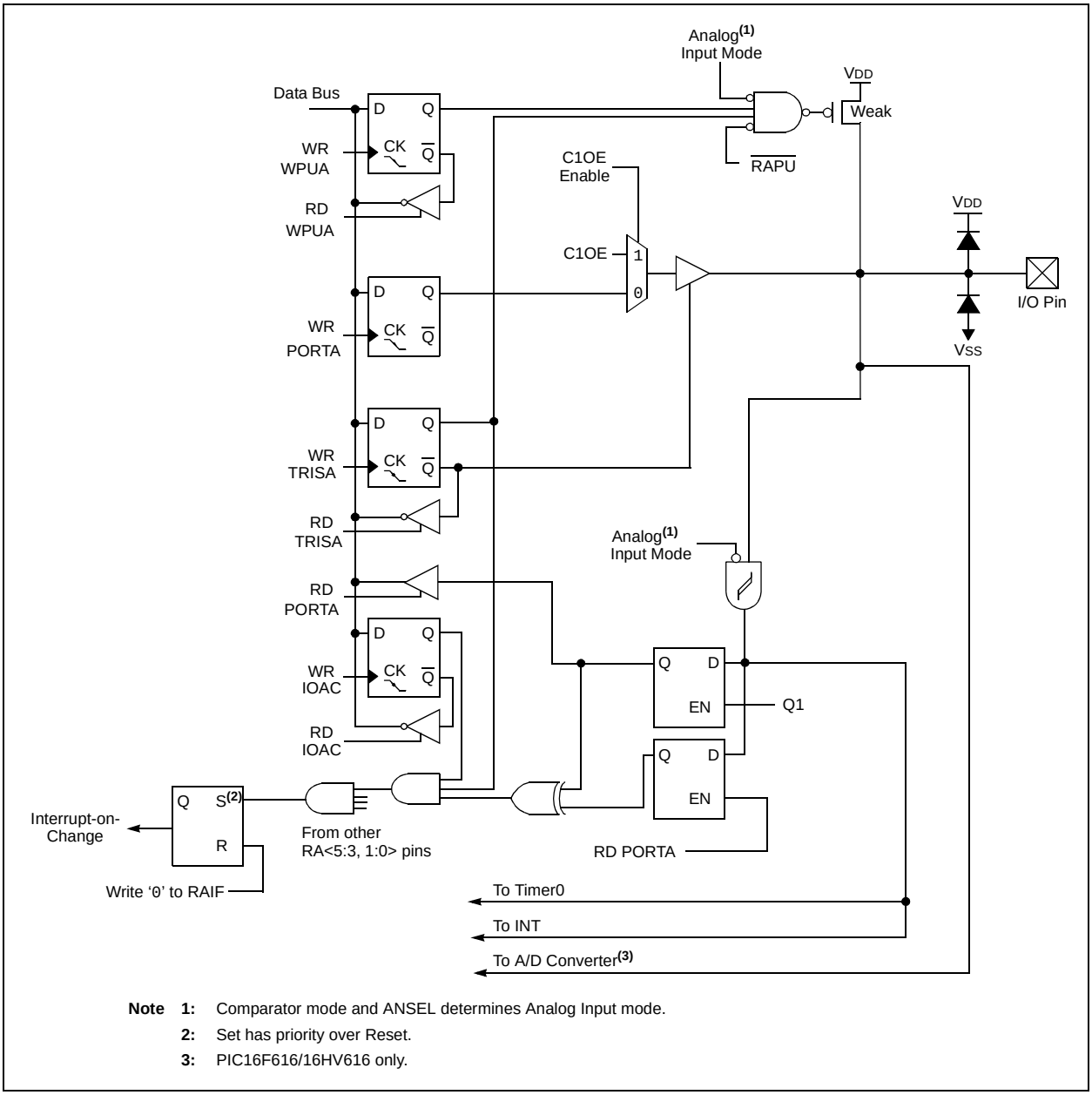
4.2.4.3 RA2/AN2(1)/T0CKI/INT/C1OUT

Figure 4-2 shows the diagram for this pin. The RA2 pin is configurable to function as one of the following:

- a general purpose I/O
- an analog input for the ADC(1)
- the clock input for TMR0
- an external edge triggered interrupt
- a digital output from Comparator C1

Note 1: PIC16F616/16HV616 only.

FIGURE 4-2: BLOCK DIAGRAM OF RA2



Note 1: Comparator mode and ANSEL determines Analog Input mode.
2: Set has priority over Reset.
3: PIC16F616/16HV616 only.

NOTES:

REGISTER 8-4: SRCON0: SR LATCH CONTROL 0 REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/S-0	R/S-0	U-0	R/W-0
SR1(2)	SR0(2)	C1SEN	C2REN	PULSS	PULSR	—	SRCLKEN
bit 7							bit 0

Legend:		S = Bit is set only -	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **SR1:** SR Latch Configuration bit(2)
- 1 = C2OUT pin is the latch $\overline{Q}$ output
- 0 = C2OUT pin is the C2 comparator output

bit 6 **SR0:** SR Latch Configuration bits(2)
- 1 = C1OUT pin is the latch Q output
- 0 = C1OUT pin is the C1 Comparator output

bit 5 **C1SEN:** C1 Set Enable bit
- 1 = C1 comparator output sets SR latch
- 0 = C1 comparator output has no effect on SR latch

bit 4 **C2REN:** C2 Reset Enable bit
- 1 = C2 comparator output resets SR latch
- 0 = C2 comparator output has no effect on SR latch

bit 3 **PULSS:** Pulse the SET Input of the SR Latch bit
- 1 = Triggers pulse generator to set SR latch. Bit is immediately reset by hardware.
- 0 = Does not trigger pulse generator

bit 2 **PULSR:** Pulse the Reset Input of the SR Latch bit
- 1 = Triggers pulse generator to reset SR latch. Bit is immediately reset by hardware.
- 0 = Does not trigger pulse generator

bit 1 **Unimplemented:** Read as '0'

bit 0 **SRCLKEN:** SR Latch Set Clock Enable bit
- 1 = Set input of SR latch is pulsed with SRCLK
- 0 = Set input of SR latch is not pulsed with the SRCLK

Note 1: The C1OUT and C2OUT bits in the CMxCON0 register will always reflect the actual comparator output (not the level on the pin), regardless of the SR latch operation.

2: To enable an SR Latch output to the pin, the appropriate CxOE, and TRIS bits must be properly configured.

REGISTER 8-5: SRCON1: SR LATCH CONTROL 1 REGISTER

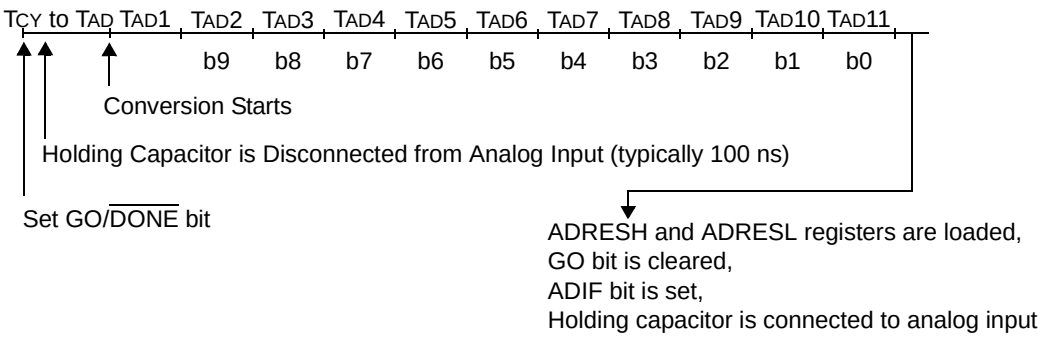
R/W-0	R/W-0	U-0	U-0	U-0	U-0	U-0	U-0
SRCS1	SRCS0	—	—	—	—	—	—
bit 7							bit 0

Legend:		S = Bit is set only -	
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-6 **SRCS<1:0>:** SR Latch Clock Prescale bits
- 00 = Fosc/16
- 01 = Fosc/32
- 10 = Fosc/64
- 11 = Fosc/128

bit 5-0 **Unimplemented:** Read as '0'

FIGURE 9-2: ANALOG-TO-DIGITAL CONVERSION TAD CYCLES



9.1.5 INTERRUPTS

The ADC module allows for the ability to generate an interrupt upon completion of an analog-to-digital conversion. The ADC interrupt flag is the ADIF bit in the PIR1 register. The ADC interrupt enable is the ADIE bit in the PIE1 register. The ADIF bit must be cleared in software.

Note:	The ADIF bit is set at the completion of every conversion, regardless of whether or not the ADC interrupt is enabled.

This interrupt can be generated while the device is operating or while in Sleep. If the device is in Sleep, the interrupt will wake-up the device. Upon waking from Sleep, the next instruction following the SLEEP instruction is always executed. If the user is attempting to wake-up from Sleep and resume in-line code execution, the global interrupt must be disabled. If the global interrupt is enabled, execution will switch to the interrupt service routine.

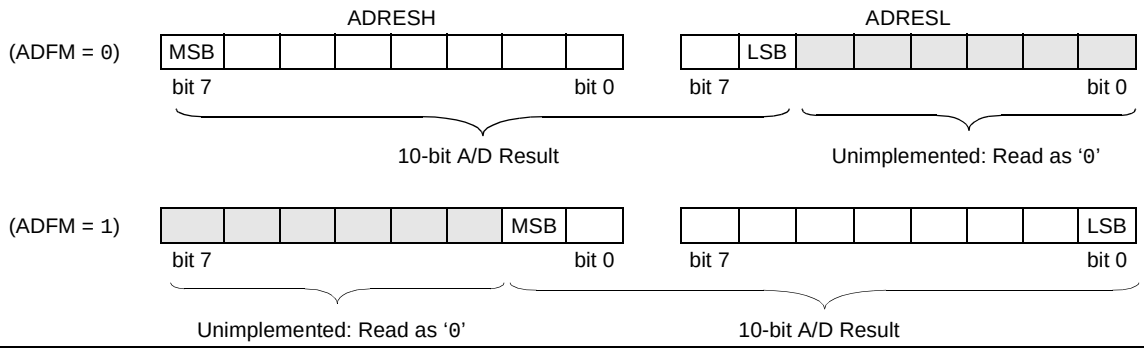
Please see **Section 9.1.5 "Interrupts"** for more information.

9.1.6 RESULT FORMATTING

The 10-bit A/D conversion result can be supplied in two formats, left justified or right justified. The ADFM bit of the ADCON0 register controls the output format.

Figure 9-4 shows the two output formats.

FIGURE 9-3: 10-BIT A/D CONVERSION RESULT FORMAT



9.2 ADC Operation

9.2.1 STARTING A CONVERSION

To enable the ADC module, the ADON bit of the ADCON0 register must be set to a '1'. Setting the GO/DONE bit of the ADCON0 register to a '1' will start the analog-to-digital conversion.

Note:	The GO/DONE bit should not be set in the same instruction that turns on the ADC. Refer to **Section 9.2.6 "A/D Conversion Procedure"**.

9.2.2 COMPLETION OF A CONVERSION

When the conversion is complete, the ADC module will:

- Clear the GO/DONE bit
- Set the ADIF flag bit
- Update the ADRESH:ADRESL registers with new conversion result

9.2.3 TERMINATING A CONVERSION

If a conversion must be terminated before completion, the GO/DONE bit can be cleared in software. The ADRESH:ADRESL registers will not be updated with the partially complete analog-to-digital conversion sample. Instead, the ADRESH:ADRESL register pair will retain the value of the previous conversion. Additionally, a 2 TAD delay is required before another acquisition can be initiated. Following this delay, an input acquisition is automatically started on the selected channel.

Note:	A device Reset forces all registers to their Reset state. Thus, the ADC module is turned off and any pending conversion is terminated.

9.2.4 ADC OPERATION DURING SLEEP

The ADC module can operate during Sleep. This requires the ADC clock source to be set to the FRC option. When the FRC clock source is selected, the ADC waits one additional instruction before starting the conversion. This allows the SLEEP instruction to be executed, which can reduce system noise during the conversion. If the ADC interrupt is enabled, the device will wake-up from Sleep when the conversion completes. If the ADC interrupt is disabled, the ADC module is turned off after the conversion completes, although the ADON bit remains set.

When the ADC clock source is something other than FRC, a SLEEP instruction causes the present conversion to be aborted and the ADC module is turned off, although the ADON bit remains set.

9.2.5 SPECIAL EVENT TRIGGER

The ECCP Special Event Trigger allows periodic ADC measurements without software intervention. When this trigger occurs, the GO/DONE bit is set by hardware and the Timer1 counter resets to zero.

Using the Special Event Trigger does not ensure proper ADC timing. It is the user's responsibility to ensure that the ADC timing requirements are met.

See **Section 10.0 "Enhanced Capture/Compare/PWM (With Auto-Shutdown and Dead Band) Module (PIC16F616/16HV616 Only)"** for more information.

9.2.6 A/D CONVERSION PROCEDURE

This is an example procedure for using the ADC to perform an analog-to-digital conversion:

1. Configure Port:
   - Disable pin output driver (See TRIS register)
   - Configure pin as analog
2. Configure the ADC module:
   - Select ADC conversion clock
   - Configure voltage reference
   - Select ADC input channel
   - Select result format
   - Turn on ADC module
3. Configure ADC interrupt (optional):
   - Clear ADC interrupt flag
   - Enable ADC interrupt
   - Enable peripheral interrupt
   - Enable global interrupt**(1)**
4. Wait the required acquisition time**(2)**.
5. Start conversion by setting the GO/DONE bit.
6. Wait for ADC conversion to complete by one of the following:
   - Polling the GO/DONE bit
   - Waiting for the ADC interrupt (interrupts enabled)
7. Read ADC Result
8. Clear the ADC interrupt flag (required if interrupt is enabled).

Note 1:	The global interrupt may be disabled if the user is attempting to wake-up from Sleep and resume in-line code execution.
2:	See **Section 9.3 "A/D Acquisition Requirements"**.

REGISTER 9-2: ADCON1: A/D CONTROL REGISTER 1

U-0	R/W-0	R/W-0	R/W-0	U-0	U-0	U-0	U-0
—	ADCS2	ADCS1	ADCS0	—	—	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **Unimplemented:** Read as '0'

bit 6-4 **ADCS<2:0>:** A/D Conversion Clock Select bits
000 = FOSC/2
001 = FOSC/8
010 = FOSC/32
x11 = FRC (clock derived from a dedicated internal oscillator = 500 kHz max)
100 = FOSC/4
101 = FOSC/16
110 = FOSC/64

bit 3-0 **Unimplemented:** Read as '0'

10.3.1 PWM PERIOD

The PWM period is specified by writing to the PR2 register of Timer2. The PWM period can be calculated using the formula of Equation 10-1.

EQUATION 10-1: PWM PERIOD

$$PWM\ Period = [(PR2) + 1] \bullet 4 \bullet T_{OSC} \bullet (TMR2\ Prescale\ Value)$$

When TMR2 is equal to PR2, the following three events occur on the next increment cycle:

- TMR2 is cleared
- The CCP1 pin is set. (Exception: If the PWM duty cycle = 0%, the pin will not be set.)
- The PWM duty cycle is latched from CCPR1L into CCPR1H.

Note:	The Timer2 postscaler (see **Section 7.1 "Timer2 Operation"**) is not used in the determination of the PWM frequency.

10.3.2 PWM DUTY CYCLE

The PWM duty cycle is specified by writing a 10-bit value to multiple registers: CCPR1L register and CCP1<1:0> bits of the CCP1CON register. The CCPR1L contains the eight MSbs and the CCP1<1:0> bits of the CCP1CON register contain the two LSbs. CCPR1L and CCP1<1:0> bits of the CCP1CON register can be written to at any time. The duty cycle value is not latched into CCPR1H until after the period completes (i.e., a match between PR2 and TMR2 registers occurs). While using the PWM, the CCPR1H register is read-only.

Equation 10-2 is used to calculate the PWM pulse width.

Equation 10-3 is used to calculate the PWM duty cycle ratio.

EQUATION 10-2: PULSE WIDTH

$$Pulse\ Width = (CCPR1L:CCP1CON<5:4>) \bullet T_{OSC} \bullet (TMR2\ Prescale\ Value)$$

EQUATION 10-3: DUTY CYCLE RATIO

$$Duty\ Cycle\ Ratio = \frac{(CCPR1L:CCP1CON<5:4>)}{4(PR2 + 1)}$$

The CCPR1H register and a 2-bit internal latch are used to double buffer the PWM duty cycle. This double buffering is essential for glitchless PWM operation.

The 8-bit timer TMR2 register is concatenated with either the 2-bit internal system clock (FOSC), or 2 bits of the prescaler, to create the 10-bit time base. The system clock is used if the Timer2 prescaler is set to 1:1.

When the 10-bit time base matches the CCPR1H and 2-bit latch, then the CCP1 pin is cleared (see Figure 10-3).

10.3.3 PWM RESOLUTION

The resolution determines the number of available duty cycles for a given period. For example, a 10-bit resolution will result in 1024 discrete duty cycles, whereas an 8-bit resolution will result in 256 discrete duty cycles.

The maximum PWM resolution is 10 bits when PR2 is 255. The resolution is a function of the PR2 register value as shown by Equation 10-4.

EQUATION 10-4: PWM RESOLUTION

$$Resolution = \frac{\log[4(PR2 + 1)]}{\log(2)}\ bits$$

Note:	If the pulse width value is greater than the period the assigned PWM pin(s) will remain unchanged.

TABLE 10-4: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS (FOSC = 20 MHz)

PWM Frequency	1.22 kHz	4.88 kHz	19.53 kHz	78.12 kHz	156.3 kHz	208.3 kHz
Timer Prescale (1, 4, 16)	16	4	1	1	1	1
PR2 Value	0xFF	0xFF	0xFF	0x3F	0x1F	0x17
Maximum Resolution (bits)	10	10	10	8	7	6.6

TABLE 10-5: EXAMPLE PWM FREQUENCIES AND RESOLUTIONS (FOSC = 8 MHz)

PWM Frequency	1.22 kHz	4.90 kHz	19.61 kHz	76.92 kHz	153.85 kHz	200.0 kHz
Timer Prescale (1, 4, 16)	16	4	1	1	1	1
PR2 Value	0x65	0x65	0x65	0x19	0x0C	0x09
Maximum Resolution (bits)	8	8	8	6	5	5

MOVF **Move f**

Syntax: [*label*] MOVF f,d

Operands: $0 \le f \le 127$
$d \in [0,1]$

Operation: (f) → (dest)

Status Affected: Z

Description: The contents of register 'f' is moved to a destination dependent upon the status of 'd'. If d = 0, destination is W register. If d = 1, the destination is file register 'f' itself. d = 1 is useful to test a file register since status flag Z is affected.

Words: 1

Cycles: 1

Example:
```
MOVF    FSR, 0
```
After Instruction
W = value in FSR register
Z = 1

MOVWF **Move W to f**

Syntax: [*label*] MOVWF f

Operands: $0 \le f \le 127$

Operation: (W) → (f)

Status Affected: None

Description: Move data from W register to register 'f'.

Words: 1

Cycles: 1

Example:
```
MOVW    OPTION
F
```
Before Instruction
OPTION = 0xFF
W = 0x4F
After Instruction
OPTION = 0x4F
W = 0x4F

MOVLW **Move literal to W**

Syntax: [*label*] MOVLW k

Operands: $0 \le k \le 255$

Operation: k → (W)

Status Affected: None

Description: The eight-bit literal 'k' is loaded into W register. The "don't cares" will assemble as '0's.

Words: 1

Cycles: 1

Example:
```
MOVLW   0x5A
```
After Instruction
W = 0x5A

NOP **No Operation**

Syntax: [*label*] NOP

Operands: None

Operation: No operation

Status Affected: None

Description: No operation.

Words: 1

Cycles: 1

Example:
```
NOP
```

15.3 DC Characteristics: PIC16HV610/616-I (Industrial) PIC16HV610/616-E (Extended)

DC CHARACTERISTICS		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial -40°C ≤ TA ≤ +125°C for extended					
Param No.	Device Characteristics	Min	Typ†	Max	Units	Conditions	
						VDD	Note
D010	**Supply Current (IDD)(1, 2)** PIC16HV610/616	—	160	230	µA	2.0	FOSC = 32 kHz LP Oscillator mode
		—	240	310	µA	3.0	
		—	280	400	µA	4.5	
D011*		—	270	380	µA	2.0	FOSC = 1 MHz XT Oscillator mode
		—	400	560	µA	3.0	
		—	520	780	µA	4.5	
D012		—	380	540	µA	2.0	FOSC = 4 MHz XT Oscillator mode
		—	575	810	µA	3.0	
		—	0.875	1.3	mA	4.5	
D013*		—	215	310	µA	2.0	FOSC = 1 MHz EC Oscillator mode
		—	375	565	µA	3.0	
		—	570	870	µA	4.5	
D014		—	330	475	µA	2.0	FOSC = 4 MHz EC Oscillator mode
		—	550	800	µA	3.0	
		—	0.85	1.2	mA	4.5	
D016*		—	310	435	µA	2.0	FOSC = 4 MHz INTOSC mode
		—	500	700	µA	3.0	
		—	0.74	1.1	mA	4.5	
D017		—	460	650	µA	2.0	FOSC = 8 MHz INTOSC mode
		—	0.75	1.1	mA	3.0	
		—	1.2	1.6	mA	4.5	
D018		—	320	465	µA	2.0	FOSC = 4 MHz EXTRC mode(3)
		—	510	750	µA	3.0	
		—	0.770	1.0	mA	4.5	
D019		—	2.5	3.4	mA	4.5	FOSC = 20 MHz HS Oscillator mode

* These parameters are characterized but not tested.

† Data in "Typ" column is at 4.5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: The test conditions for all IDD measurements in active operation mode are: OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; $\overline{MCLR}$ = VDD; WDT disabled.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors, such as I/O pin loading and switching rate, oscillator type, internal code execution pattern and temperature, also have an impact on the current consumption.

3: For RC oscillator configurations, current through REXT is not included. The current through the resistor can be extended by the formula IR = VDD/2REXT (mA) with REXT in kΩ.

TABLE 15-7: COMPARATOR SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated) Operating Temperature -40°C ≤ TA ≤ +125°C								
Param No.	**Sym**	**Characteristics**		**Min**	**Typ†**	**Max**	**Units**	**Comments**
CM01	VOS	Input Offset Voltage(2)		—	± 5.0	± 10	mV	
CM02	VCM	Input Common Mode Voltage		0	—	VDD – 1.5	V	
CM03*	CMRR	Common Mode Rejection Ratio		+55	—	—	dB	
CM04*	TRT	Response Time(1)	Falling	—	150	600	ns	
			Rising	—	200	1000	ns	
CM05*	TMC2COV	Comparator Mode Change to Output Valid		—	—	10	µs	
CM06*	VHYS	Input Hysteresis Voltage		—	45	60	mV	

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Response time is measured with one comparator input at (VDD - 1.5)/2 - 100 mV to (VDD - 1.5)/2 + 20 mV. The other input is at (VDD -1.5)/2.

2: Input offset voltage is measured with one comparator input at (VDD - 1.5V)/2.

TABLE 15-8: COMPARATOR VOLTAGE REFERENCE (CVREF) SPECIFICATIONS

Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +125°C							
Param No.	**Sym**	**Characteristics**	**Min**	**Typ†**	**Max**	**Units**	**Comments**
CV01	CLSB	Step Size(2)	— —	VDD/24 VDD/32	— —	V V	Low Range (VRR = 1) High Range (VRR = 0)
CV02	CACC	Absolute Accuracy(3)	— —	— —	± 1/2 ± 1/2	LSb LSb	Low Range (VRR = 1) High Range (VRR = 0)
CV03	CR	Unit Resistor Value (R)	—	2k	—	Ω	
CV04	CST	Settling Time(1)	—	—	10	µs	

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: Settling time measured while VRR = 1 and VR<3:0> transitions from '0000' to '1111'.

2: See **Section 8.11 "Comparator Voltage Reference"** for more information.

3: Absolute Accuracy when CVREF output is ≤ (VDD-1.5).

TABLE 15-9: VOLTAGE REFERENCE SPECIFICATIONS

VR Voltage Reference Specifications			**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +125°C				
Param No.	**Symbol**	**Characteristics**	**Min**	**Typ**	**Max**	**Units**	**Comments**
VR01	VP6OUT	VP6 voltage output	0.50	0.6	0.7	V	
VR02	V1P2OUT	V1P2 voltage output	1.05	1.20	1.35	V	
VR03*	TSTABLE	Settling Time	—	10	—	µs	

* These parameters are characterized but not tested.

TABLE 15-14: DC CHARACTERISTICS FOR IDD SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Device Characteristics	Units	Min	Typ	Max	Condition	
						VDD	Note
D010	Supply Current (IDD)	μA	—	13	58	2.0	IDD LP OSC (32 kHz)
			—	19	67	3.0	
			—	32	92	5.0	
D011		μA	—	135	316	2.0	IDD XT OSC (1 MHz)
			—	185	400	3.0	
			—	300	537	5.0	
D012		μA	—	240	495	2.0	IDD XT OSC (4 MHz)
			—	360	680	3.0	
		mA	—	0.660	1.20	5.0	
D013		μA	—	75	158	2.0	IDD EC OSC (1 MHz)
			—	155	338	3.0	
			—	345	792	5.0	
D014		μA	—	185	357	2.0	IDD EC OSC (4 MHz)
			—	325	625	3.0	
		mA	—	0.665	1.30	5.0	
D016		μA	—	245	476	2.0	IDD INTOSC (4 MHz)
			—	360	672	3.0	
			—	620	1.10	5.0	
D017		μA	—	395	757	2.0	IDD INTOSC (8 MHz)
		mA	—	0.620	1.20	3.0	
			—	1.20	2.20	5.0	
D018		μA	—	175	332	2.0	IDD EXTRC (4 MHz)
			—	285	518	3.0	
			—	530	972	5.0	
D019		mA	—	2.20	4.10	4.5	IDD HS OSC (20 MHz)
			—	2.80	4.80	5.0	

TABLE 15-15: DC CHARACTERISTICS FOR I_{PD} SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Device Characteristics	Units	Min	Typ	Max	Condition	
						V_{DD}	Note
D020E	Power Down I_{PD}	µA	—	0.05	12	2.0	I_{PD} Base
			—	0.15	13	3.0	
			—	0.35	14	5.0	
D021E		µA	—	0.5	20	2.0	WDT Current
			—	2.5	25	3.0	
			—	9.5	36	5.0	
D022E		µA	—	5.0	28	3.0	BOR Current
			—	6.0	36	5.0	
D023E		µA	—	105	195	2.0	I_{PD} Current (Both Comparators Enabled)
			—	110	210	3.0	
			—	116	220	5.0	
		µA	—	50	105	2.0	I_{PD} Current (One Comparator Enabled)
			—	55	110	3.0	
			—	60	125	5.0	
D024E		µA	—	30	58	2.0	I_{PD} (C_{VREF}, High Range)
			—	45	85	3.0	
			—	75	142	5.0	
D025E		µA	—	39	76	2.0	I_{PD} (C_{VREF}, Low Range)
			—	59	114	3.0	
			—	98	190	5.0	
D026E		µA	—	5.5	30	2.0	I_{PD} (T1 OSC, 32 kHz)
			—	7.0	35	3.0	
			—	8.5	45	5.0	
D027E		µA	—	0.2	12	3.0	I_{PD} (A2D on, not converting)
			—	0.3	15	5.0	

TABLE 15-16: WATCHDOG TIMER SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Sym	Characteristic	Units	Min	Typ	Max	Conditions
31	T_{WDT}	Watchdog Timer Time-out Period (No Prescaler)	ms	6	20	70	150°C Temperature

TABLE 15-17: LEAKAGE CURRENT SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Sym	Characteristic	Units	Min	Typ	Max	Conditions
D061	I_{IL}	Input Leakage Current(1) (GP3/RA3/$\overline{MCLR}$)	µA	—	±0.5	±5.0	$V_{SS} \le V_{PIN} \le V_{DD}$
D062	I_{IL}	Input Leakage Current(2) (GP3/RA3/$\overline{MCLR}$)	µA	50	250	400	V_{DD} = 5.0V

Note 1: This specification applies when GP3/RA3/$\overline{MCLR}$ is configured as an input with the pull-up disabled. The leakage current for the GP3/RA3/$\overline{MCLR}$ pin is higher than for the standard I/O port pins.

2: This specification applies when GP3/RA3/$\overline{MCLR}$ is configured as the $\overline{MCLR}$ Reset pin function with the weak pull-up enabled.

TABLE 15-18: OSCILLATOR PARAMETERS FOR PIC16F616 – H (High Temp.)

Param No.	Sym	Characteristic	Frequency Tolerance	Units	Min	Typ	Max	Conditions
OS08	INTOSC	Int. Calibrated INTOSC Freq.(1)	±10%	MHz	7.2	8.0	8.8	2.0V ≤ VDD ≤ 5.5V -40°C ≤ TA ≤ 150°C

Note 1: To ensure these oscillator frequency tolerances, VDD and VSS must be capacitively decoupled as close to the device as possible. 0.1 µF and 0.01 µF values in parallel are recommended.

TABLE 15-19: COMPARATOR SPECIFICATIONS FOR PIC16F616 – H (High Temp.)

Param No.	Sym	Characteristic	Units	Min	Typ	Max	Conditions
CM01	VOS	Input Offset Voltage	mV	—	±5	±20	(VDD - 1.5)/2

FIGURE 16-29: PIC16HV610/616 IPD COMPARATOR (BOTH ON) vs. VDD

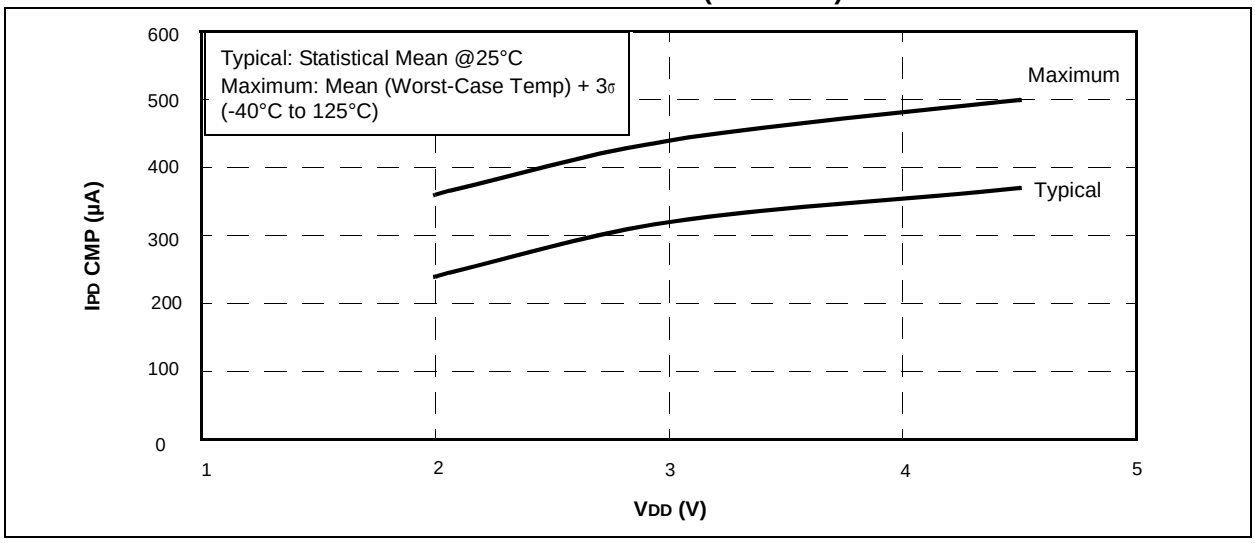


FIGURE 16-30: PIC16HV610/616 IPD WDT vs. VDD

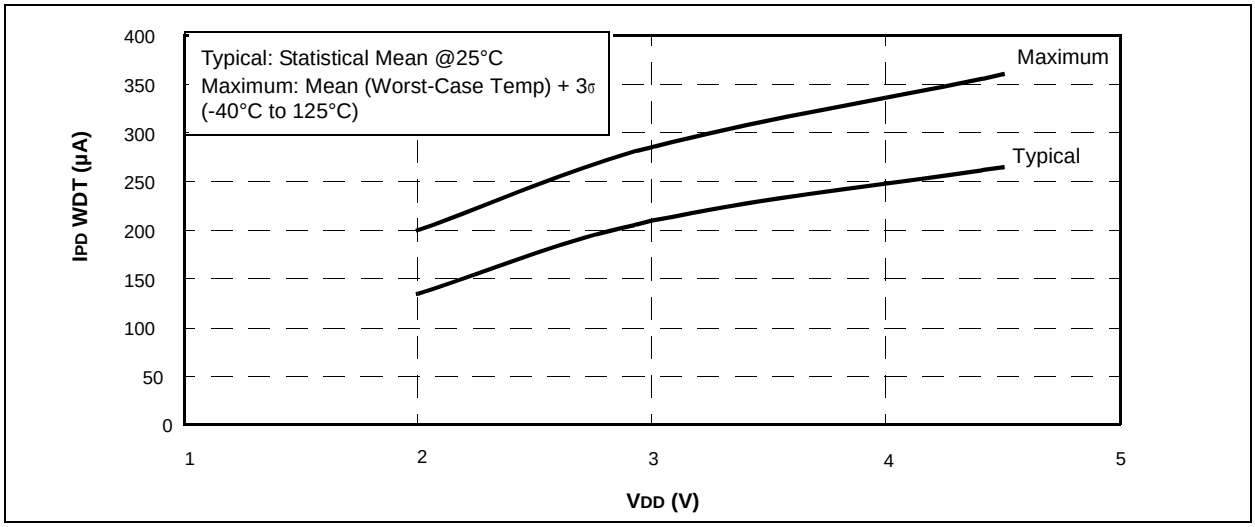


FIGURE 16-31: PIC16HV610/616 IPD BOR vs. VDD

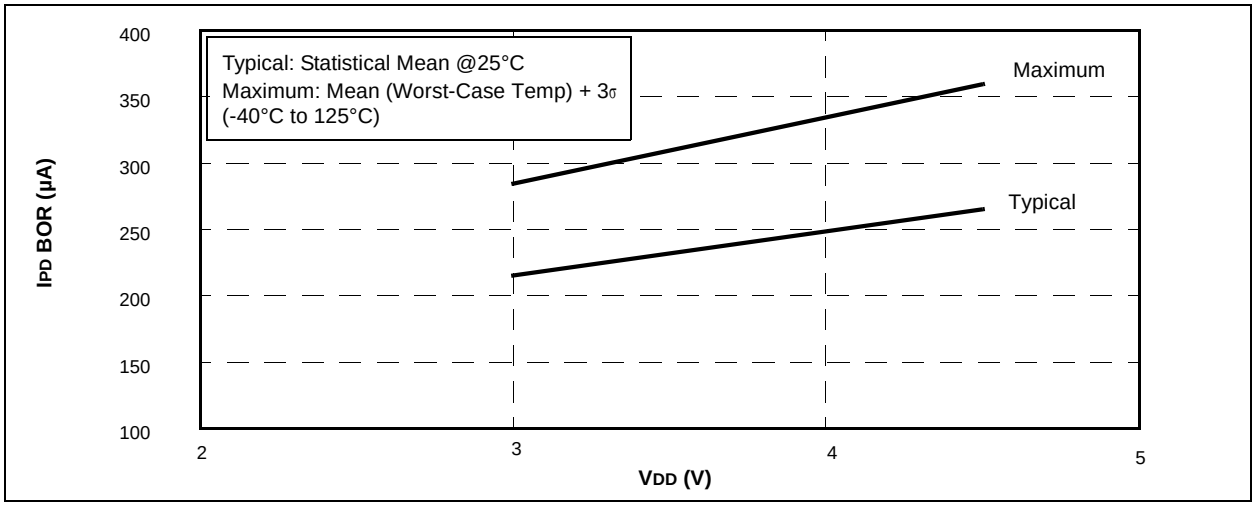


FIGURE 16-52: SHUNT REGULATOR VOLTAGE vs. TEMP (TYPICAL)

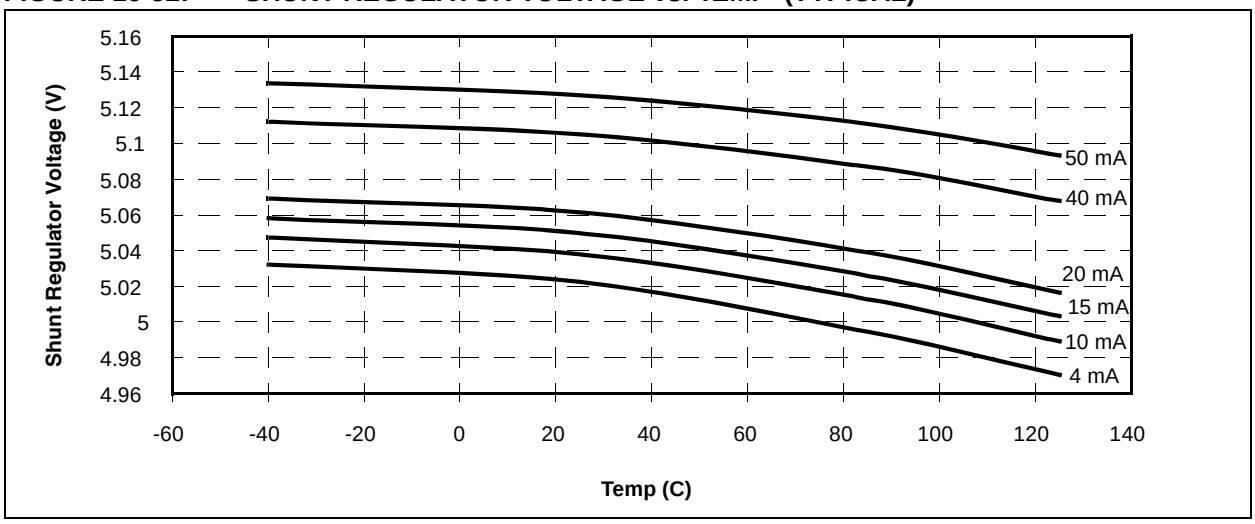
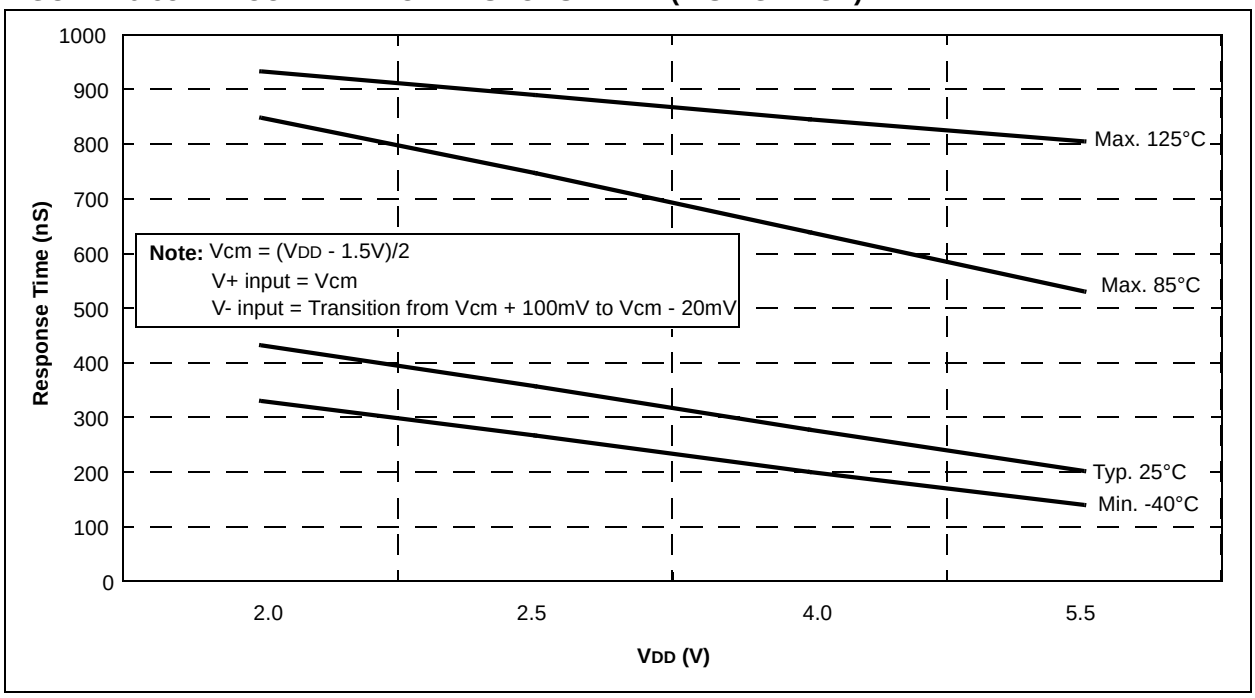


FIGURE 16-53: COMPARATOR RESPONSE TIME (RISING EDGE)



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